



Material Content Data Sheet



Sales Product Name	ESD230-B1-W0201 E6327			Issued	24. January 2018			
MA#	MA001607790							
Package	SG-WLL-2-1			Weight*	0.06 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.063	99.77	99.77	997684	997684
passivation	inorganic material	SiO2	60676-86-0	0.000	0.07		730	
	inorganic material	siliciumnitride	12033-89-5	0.000	0.16	0.23	1586	2316
*deviation	< 10%			Sum in total:		100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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